

Electronic Patent Application Fee Transmittal

Application Number:	10565682			
Filing Date:	28-Jun-2006			
Title of Invention:	SILICON-CONTAINING POLYMER, PROCESS FOR PRODUCING THE SAME, HEAT-RESISTANT RESIN COMPOSITION, AND HEAT-RESISTANT FILM			
First Named Inventor/Applicant Name:	Kunikazu Tauchi			
Filer:	Marvin Jay Spivak/Mimi Chanthaphone			
Attorney Docket Number:	284679US0PCT			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				1810